# IBIS Chair's Report

Randy Wolff
Micron Technology
Chair, IBIS Open Forum

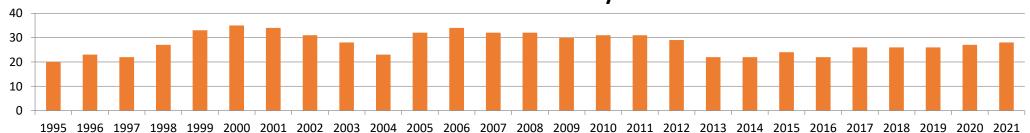
EMC+SIPI Virtual IBIS Summit August 12, 2021



## 28 IBIS Members (Organization-based)



#### **Number of Members by Year**



## IBIS Officers June 2021- May 2022

Chair: Randy Wolff, Micron Technology

Vice-Chair: Lance Wang, Zuken USA

Secretary: Mike LaBonte, SiSoft (MathWorks)

Treasurer: Bob Ross, Teraspeed Labs

Librarian: Zhiping Yang, Google (Waymo)

Postmaster: Curtis Clark, ANSYS

Webmaster: Steve Parker, Marvell



### IBIS Meetings

- Weekly teleconferences
  - Quality task group (Tuesdays, 09:00 PT)
  - Advanced Technology Modeling (ATM) task group (Tuesdays, 12:00 PT)
  - Interconnect task group (Wednesdays, 08:00 PT)
    - Currently suspended as Editorial task group prepares IBIS 7.1 document
  - Editorial task group (Wednesdays, 08:00 PT)
- IBIS Open Forum teleconference every 3 weeks (Fridays, 08:00 PT)
- IBIS Summit meetings (USA and international)
  - DesignCon, IEEE SPI, IEEE EMC+SIPI, Shanghai, Taipei, Tokyo (JEITA-organized)
- Participants: ~323 in 2020



### SAE ITC

- SAE Industry Technologies Consortia is the parent organization of the IBIS Open Forum
- IBIS is assisted by SAE employees José Godoy, Phyllis Gross, and Laurie Strom
- SAE ITC provides financial, legal, and other services
- https://www.sae-itc.com/



### Task Groups

- Advanced Technology Modeling Task Group
  - Chair: Arpad Muranyi, Siemens EDA
  - https://ibis.org/atm\_wip/
  - Develop non-interconnect technical BIRDs
- Editorial Task Group
  - Chair: Michael Mirmak, Intel
  - https://ibis.org/editorial\_wip/
  - Produce IBIS specification documents
- Interconnect Task Group
  - · Chair: Michael Mirmak, Intel
  - https://ibis.org/interconn\_wip/
  - Develop on-die/package/module/connector interconnect modeling BIRDs
- Quality Task Group
  - Chair: Mike LaBonte, SiSoft (MathWorks)
  - https://ibis.org/quality\_wip/
  - Oversee IBISCHK parser testing and development



BIRD = Buffer Issue Resolution Document

### **IBIS** Milestones

#### I/O Buffer Information Specification

- 1993-1994 IBIS 1.0-2.1:
  - Behavioral buffer model (fast simulation)
  - Component pin map (easy EDA import)
- 1997-1999 IBIS 3.0-3.2:
  - Package models
  - Electrical Board Description (EBD)
- 2002-2006 **IBIS 4.0-4.2**:
  - Receiver models
  - AMS languages
- 2007-2012 **IBIS 5.0-5.1**:
  - IBIS-AMI SerDes models
  - Power-aware model

#### I/O Buffer Information Specification

- 2013-2015 **IBIS 6.0-6.1**:
  - PAM4 multi-level signaling
  - Power delivery package models
- 2019 **IBIS 7.0**:
  - Back-channel time-domain support
  - Interconnect modeling using IBIS-ISS and Touchstone
- 2021 IBIS 7.1 (in progress)
  - DDRx IBIS-AMI support
  - Electrical Module Description (EMD)
  - IBIS-AMI back-channel statistical optimization

#### Other Work

- 1995: ANSI/EIA-656 (IBIS 2.1 International standard)
- 1999: ANSI/EIA-656-A (IBIS 3.2 International standard)
- 2001: IEC 62014-1 (IBIS 3.2 International standard)
- 2003: Interconnect Model Specification (ICM 1.0)
- 2006: ANSI/EIA-656-B (IBIS 4.2 International standard)
- 2009: Touchstone 2.0
  - Official Touchstone donated from Agilent/Keysight
- 2011: IBIS-ISS 1.0 (Interconnect SPICE Subcircuit)
  - Subset of HSPICE
- IBISCHK: IBIS file syntax parser
  - Current version 7.0.2
  - Source code available for purchase
  - Compiled executables available free of charge
- TSCHK2: Touchstone 2.0 file syntax parser
  - Current version 2.0.1
  - Source code available for purchase
  - Compiled executables available free of charge

## Planning for IBIS Version 7.1

Official BIRD content for IBIS 7.1 based on Open Forum vote held July 16, 2021.

BIRD ID	BIRD Title	Approval Date	Notes
195.1	Enabling [Rgnd] and [Rpower] Keywords for Input Models	August 31, 2018	IBIS-AMI
197.7	New AMI Reserved Parameter DC Offset	February 21, 2020	IBIS-AMI (for DDRx)
198.3	Keyword Additions for On-Die PDN (Power Distribution Network) Modeling	August 7, 2020	Power Integrity
199	Fix Rx Receiver Sensitivity Inconsistencies	June 7, 2019	IBIS-AMI
200	C comp Model Using IBIS-ISS or Touchstone	September 27, 2019	[Model] C_comp
201.1	Back-channel Statistical Optimization	July 17, 2020	IBIS-AMI
202.3	Electrical Descriptions of Modules	March 12, 2021	EMD (Next Gen EBD)
203	<u>Submodel Clarification</u>	April 24, 2020	Editorial
205	New AMI Reserved Parameter for Sampling Position in AMI Init Flow	June 26, 2020	IBIS-AMI
206	Clarification of text "transition time"	September 18, 2020	Editorial
207	New AMI Reserved Parameters Component Name and Signal Name	October 9, 2020	IBIS-AMI (for DDRx)
208	Clock-Data Pin Relationship Keyword	January 8, 2021	IBIS clock/data relationship
209	Make Clock Times Output Required for Clock Executable Models	March 12, 2021	IBIS-AMI (for DDRx)
212	<u>Clarification of PAM4_UpperThreshold, PAM4_CenterThreshold, PAM4_LowerThreshold</u>	May 14, 2021	Editorial

## Planning for IBIS Version 7.1

#### Other BIRDs

BIRD ID	BIRD Title	Expected Status	
166.4	Resolving problems with Redriver Init Flow	To be rejected (in favor of BIRD211.x)	
181.1	I-V Table Clarifications	Delayed until future IBIS version	
190	<u>Clarification for Redriver Flow</u>	To be rejected (in favor of BIRD211.x)	
204	DQ DQS GetWave Flow for Clock Forwarding Modeling	Superseded by BIRD209	
210	New Redriver AMI Flow	To be rejected (in favor of BIRD211.x)	
211.x	IBIS AMI Reference Flow Improvements	Delayed until future IBIS version	
213	Extending IBIS-AMI for PAMn Analysis	Delayed until future IBIS version	

### What's Next for IBIS?

- IBIS participants have broad experience in SI and PI with unique perspectives of model creators, EDA tool vendors, system architects, and system-level simulation
- IBIS Open Forum's highly collaborative task groups are up for the challenge of addressing the SI and PI demands of new signaling technologies:
  - Expanded system-level perspective
    - Clock/data relationships, timing information, equalization training
  - PAMn (PAM3 duobinary, PAM5, etc.) including unique challenges of singleended versions
  - Potential for IBIS to enable improved modeling/analysis of PDN
    - Voltage regulator models
    - Chip power models

### Participation in IBIS

- The success of IBIS depends on active participation and volunteering
- Bringing your ideas and talents to IBIS
  - Task groups for technical discussions and document editing
  - IBIS email reflectors
  - Open Forum teleconferences for event planning and voting
  - Summit presentations
  - IBIS Board and task group volunteering
  - Writing BIRDs Buffer Issue Resolution Documents
    - Official method for submitting a proposed change to the IBIS specification
    - Many developed collaboratively in task groups
    - Discussed and voted on in Open Forum meetings



### IBIS Website Resources



## [Thank You]



IBIS Open Forum:

Web: <a href="https://www.ibis.org">https://www.ibis.org</a>

Email: info@ibis.org

We welcome participation by all IBIS model makers, EDA tool vendors, IBIS model users, and interested parties.